

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5521680

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
COVIDIEN PRIVATE LIMITED	02/12/2019
RECEIVING PARTY DATA	
Name:	MEDTRONIC INTERNATIONAL IP GMBH
Street Address:	VICTOR VON BRUNS-STRASSE 19
City:	NEUHAUSEN AM RHEINFALL
State/Country:	SWITZERLAND
Postal Code:	8212
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16162039
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Email:	rs.patents.two@medtronic.com
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Address Line 4:	NORTH HAVEN, CONNECTICUT 06473
ATTORNEY DOCKET NUMBER:	16162039
NAME OF SUBMITTER:	JOSEPH BENDER-ZANONI
SIGNATURE:	/Joseph BENDER-ZANONI, Reg. 51454/
DATE SIGNED:	05/14/2019
Total Attachments: 2	
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DEED OF ASSIGNMENT

THIS DEED OF ASSIGNMENT IS EXECUTED BY

Covidien Private Limited

Address: ~~103 Penang Road, Visioncrest Commercial # 10-01, Singapore 238467~~

(hereinafter 'Assignor')

50 Pasir Panjang Road, #04-51 Mapletree
Business City, Singapore 117384

IN FAVOUR OF

Medtronic International IP GmbH ("MIIG")

Address: Victor von Bruns-Strasse 19, 8212 Neuhausen am Rheinfall, Switzerland

(hereinafter 'Assignee')

WHEREAS the Assignor is the sole owner of invention(s) and patent application(s) titled:

"DEVICE AND METHOD FOR ATTACHMENT OF A STOMAL SLEEVE", identified by reference number: C00014240US01(203-11428), the subject of United States Patent Application No. 62/581,059 filed November 3, 2017", hereinafter referred to as the "Inventions".

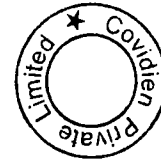
WHEREAS Assignee is desirous of acquiring the full (100%) share in the right, title and interest in, to and under the Inventions above and the patent application with the filing number listed above, including all patents that may issue thereof, and the inventions covered thereby;

NOW THEREFORE, with reference to the Research and Development Services Agreement between the Assignor and the Assignee effective as of September 25, 2010, Assignor as legal and beneficial owner hereby does assign and transfer to Assignee, its successors, legal representatives and assign absolutely and free from all incumbrances, the full interest of Assignor's right and title in the Inventions above and in the patent application with the filing number listed above as well as in all patent applications, utility model applications, design applications filed in any country and other intellectual property rights basing priority on the patent application above including the right to claim priority under the Paris Convention for the Protection of Industrial Property, all re-examination applications, all re-issue applications, and any patents, utility models, designs or other intellectual property rights which may issue for the Inventions above. All interests in property in the Inventions and applications above are herewith transferred to the Assignee.

Assignor further agrees to execute all such further papers and perform such other acts as assignee may reasonably request to obtain or maintain such patents, utility models, designs or other intellectual property rights.

Authorized signatory of Assignor

C. Clark



Signature

Name: Campbell Andrew John Clark

Place, Date: Singapore, 12 FEB 2019

[Company Seal/Stamp]

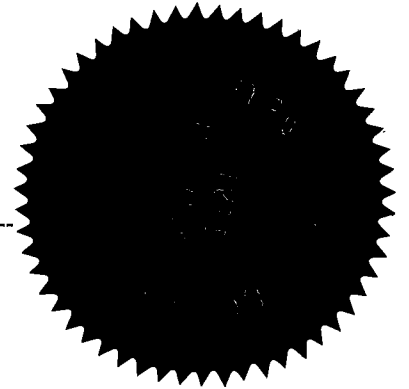
Witness of Assignor:

Choong

Signature

Name: Choong Hwei Fong

Place, Date: Singapore, 12 FEB 2019



Assignee hereby acknowledges and agrees to such assignment and transfer

Authorized signatory of Assignee

H. Olsson

Signature

Name: Hakan Olsson

Place, Date: Neuhausen, 04. April 2019

[Company Seal/Stamp]

Witness of Assignor:

N. Geden

Signature

Name: NICOLA GEDEN

Place, Date: Neuhausen, 04. April 2019